

Description

The SI7145DP-T1-GE3 uses advanced trench technology

to provide excellent $R_{\text{DS}(\text{ON})},$ low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = -30V I_D =-100A

 $R_{DS(ON)} < 4 \text{ m}\Omega \text{ V}_{GS}$ =-10V

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

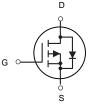
Product ID	Pack	Brand	Qty(PCS)
SI7145DP-T1-GE3	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units		
Vds	Drain-Source Voltage	n-Source Voltage -30			
Vgs	Gate-Source Voltage	±20	V		
l₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	-100	Α		
l⊳@Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	-70	А		
Ідм	Pulsed Drain Current ²	-250	А		
EAS	Single Pulse Avalanche Energy ³	80	mJ		
las	Avalanche Current	-70	A		
P _D @T _C =25°C	Total Power Dissipation ⁴	Total Power Dissipation ⁴ 120			
Тѕтс	Storage Temperature Range -55 to 150		°C		
TJ	Operating Junction Temperature Range -55 to 150		°C		
Reja	Thermal Resistance Junction-Ambient ¹ 50		°C/W		
Rejc	Thermal Resistance Junction-Case ¹	1.6	°C/W		







P-Channel MOSFET



SI7145DP-T1-GE3

P-Channel Enhancement Mode MOSFET

Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Symbol	Parameter	Parameter Conditions		Тур.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =-250uA	-30			V
R _{DS(ON)}		V _{GS} =-10V , I _D =-20A		3	4.0	mΩ
	Static Drain-Source On-Resistance ²	V _{GS} =-4.5V , I _D =-15A		4.2	6.0	mΩ
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=-250uA$	-1.2		-2.5	V
I _{DSS}		V _{DS} =-24V , V _{GS} =0V , T _J =25℃			-1	uA
	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =55℃			-5	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.2		Ω
Qg	Total Gate Charge (-10V)			60		
Q_{gs}	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-10V , I _D =-18A		9		nC
Q _{gd}	Gate-Drain Charge			15		
T _{d(on)}	Turn-On Delay Time			17		
Tr	Rise Time	V _{DD} =-15V , V _{GS} =-10V , R _G =3.3Ω,		40		ns
T _{d(off)}	Turn-Off Delay Time	I _D =-20A		55		
T _f	Fall Time			13		
C _{iss}	Input Capacitance			3450		
C _{oss}	Output Capacitance	V _{DS} =-25V , V _{GS} =0V , f=1MHz		255		pF
C _{rss}	Reverse Transfer Capacitance			140		
ls	Continuous Source Current ^{1,5}	$V_G=V_D=0V$, Force Current			-100	А
V_{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =-1A , T_{J} =25°C			-1.2	V
t _{rr}	Reverse Recovery Time	IF=-20A , di/dt=100A/µs ,		22		nS
Q _{rr}	Reverse Recovery Charge			72		nC

Note :

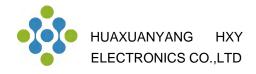
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3.The EAS data shows Max. rating . The test condition is V_{DD}=-50V,V_{GS}=-10V,L=0.1mH,I_{AS}=-40A 4.The power dissipation is limited by 150°C junction temperature

5.The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation

6.The maximum current rating is package limited.



Typical Characteristics

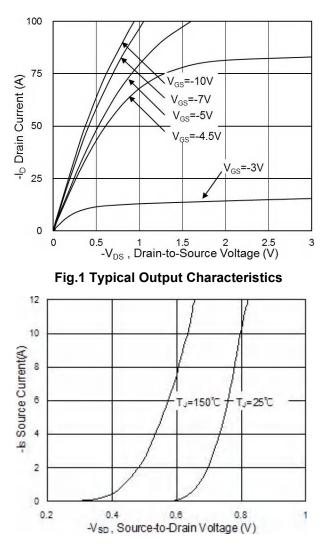
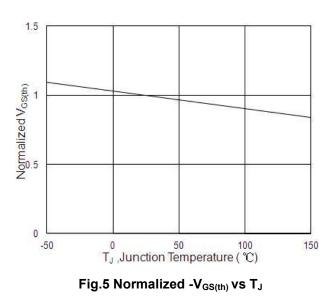
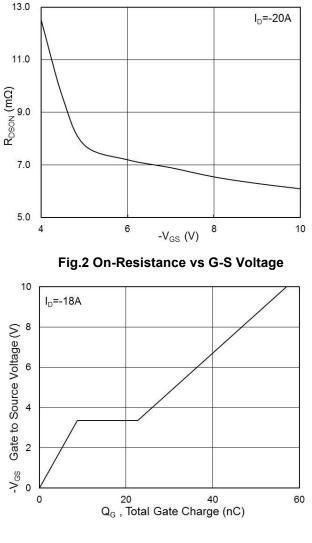
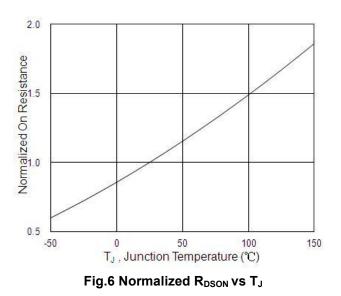


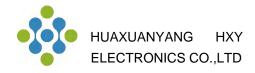
Fig.3 Source Drain Forward Characteristics











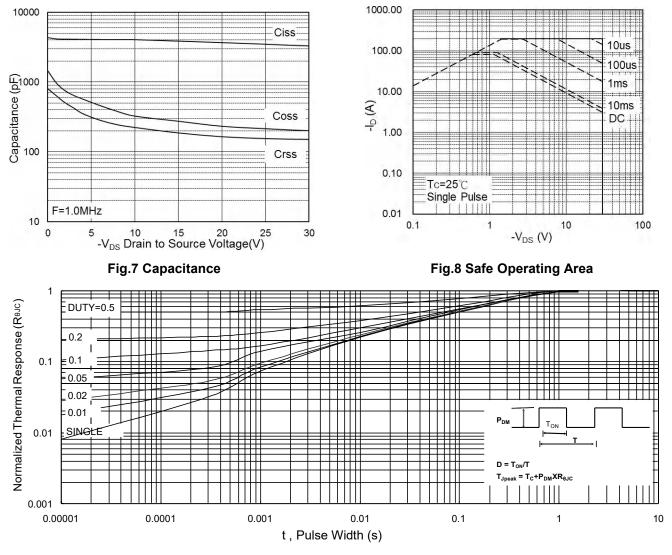


Fig.9 Normalized Maximum Transient Thermal Impedance

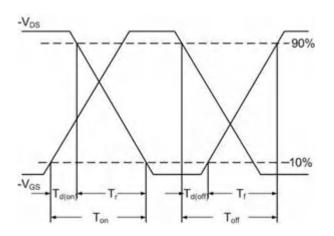
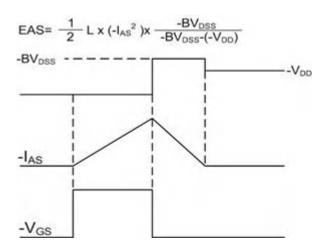


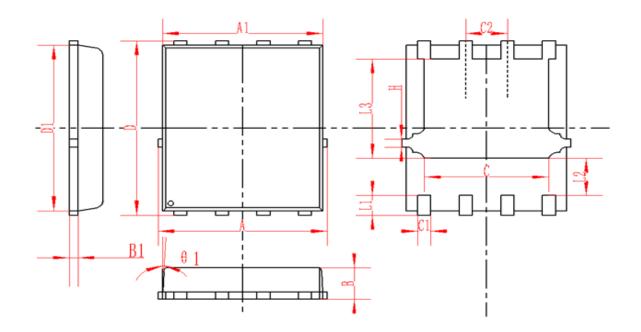
Fig.10 Switching Time Waveform







DFN5X6-8L Package Information



SYMBOL	MM		INCH			
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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